1

PI: PRODUCTION AND INDUSTRIAL ENGINEERING

EE25BTECH11023-Venkata Sai

Duration: 3 Hours Maximum Marks: 100

Read the following instructions carefully.

- 1. This question paper contains 16 printed pages including pages for rough work. Please check all pages and report discrepancy, if any.
- 2. Write your registration number, your name and name of the examination centre at the specified locations on the right half of the Optical Response Sheet (ORS).
- 3. Using HB pencil, darken the appropriate bubble under each digit of your registration number and the letters corresponding to your paper code.
- 4. All questions in this paper are of objective type.
- 5. Questions must be answered on Optical Response Sheet (ORS) by darkening the appropriate bubble (marked A, B, C, D) using HB pencil against the question number on the left hand side of the ORS. Each question has only one correct answer. In case you wish to change an answer, erase the old answer completely. More than one answer bubbled against a question will be treated as an incorrect response.
- 6. There are a total of 60 questions carrying 100 marks. Questions 1 through 20 are 1-mark questions, questions 21 through 60 are 2-mark questions.
- 7. Questions 51 through 56 (3 pairs) are common data questions and question pairs (57, 58) and (59, 60) are linked answer questions. The answer to the second question of the above 2 pairs depends on the answer to the first question of the pair. If the first question in the linked pair is wrongly answered or is un-attempted, then the answer to the second question in the pair will not be evaluated.
- 8. Un-attempted questions will carry zero marks.
- 9. Wrong answers will carry NEGATIVE marks. For Q.1 to Q.20, ½ mark will be deducted for each wrong answer. For Q. 21 to Q. 56, ½ mark will be deducted for each wrong answer. The question pairs (Q.57, Q.58), and (Q.59, Q.60) are questions with linked answers. There will be negative marks only for wrong answer to the first question of the linked answer question pair i.e. for Q.57 and Q.59, ½ mark will be deducted for each wrong answer. There is no negative marking for Q.58 and Q.60.
- 10. Calculator (without data connectivity) is allowed in the examination hall.
- 11. Charts, graph sheets or tables are NOT allowed in the examination hall.
- 12. Rough work can be done on the question paper itself. Additionally, blank pages are given at the end of the question paper for rough work.

Q. 1 - Q. 20 carry one mark each.Q.1 The homogeneous part of the differentiation of the differentiation of the differentiation.	al equation $\frac{d^2y}{dx^2} + p\frac{dy}{dx} + qy = r$ h	as real distinct roots
(A) $p^2 - 4q > 0$ (B) $p^2 - 4q < 0$	(C) $p^2 - 4q = 0$ (D) $p^2 - 4q = r$	
		(GATE PI 2009)
Q.2 The total derivative of the function xy i	S	
(A) $xdy + ydx$ (B) $xdx + ydy$	(C) $dx + dy$ (D) $dxdy$	
Q.3 A helical compression spring has: $d = w$ modulus, $G = modulus$ of rigidity and d		_
(A) $\frac{dE}{8D^3N_a}$ (B) $\frac{dG}{8D^3N_a}$	(C) $\frac{d^3E}{8DN_a}$ (D) $\frac{d^3}{8DN_a}$	
 Q.4 Which of the following processes is N superheat? (A) Isentropic expansion (B) Isentropic compression (C) Constant temperature heat addition (D) Constant temperature heat rejection 	NOT executed by an ideal Ran	
Q.5 During the numerical solution of a first known as Euler Cauchy) method with s		_
of (A) h^2 (B) h^3	(C) h ⁴	(D) h^5
Q.6 For a granted patent to last for 20 year	s, the patent must be	(GATE PI 2009)
(A) owned by the inventor(B) renewed and maintained	(C) novel (D) non-obvious	
Q.7 As per Kendall's notation in M/G/c que follows	euing system, the number of arr	(GATE PI 2009) ivals in a fixed time
(A) Beta distribution(B) Normal distribution	(C) Poisson distribution(D) Uniform distribution	

Q.8 Which of the following forecasting mode	(GATE PI 2009) els explicitly accounts for seasonality of demand?
(A) Simple moving average model(B) Simple exponential smoothing model	(C) Holt's model(D) Winter's model
	(GATE PI 2009)
Q.9 A typical Fe-C alloy containing greater t	han 0.8% C is known as
(A) Eutectoid steel(B) Hypoeutectoid steel	(C) Mild steel(D) Hypereutectoid steel
Q.10 The capacity of a material to absorb end back when unloaded is termed as	(GATE PI 2009) ergy when deformed elastically, and to release it
(A) toughness(B) resilience	(C) ductility(D) malleability
	(GATE PI 2009)
Q.11 The product of the complex numbers (3 · (A) $(1 + i^6)$ (B) $(9 - i^8)$	
	(GATE PI 2009)
Q.12 The value of the determinant $\begin{pmatrix} 4 & 1 & 1 \\ 2 & 1 & 3 \\ 1 & 3 & 2 \end{pmatrix}$ i	s
(A) -28 (B) -24	(C) 32 (D) 36
respectively, then the pitch diameter (in 1	,
(A) 7.67 (B) 15.34	(C) 34.50 (D) 69.00
Q.14 Hot chamber die casting process is NOT	(GATE PI 2009) suited for
(A) Lead and its alloys(B) Zinc and its alloys	(C) Tin and its alloys(D) Aluminum and its alloys

Q.15 The total angular movement (in degrees) of a lead-screw with a pitch of 5.0 mm to drive

(C) 57600

the work-table by a distance of 200 mm in a NC machine is

(B) 28800

(GATE PI 2009)

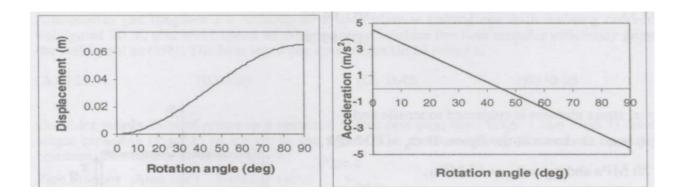
(GATE PI 2009)

(D) 72000

Q.16 Anisotropy in rolled components is caused by

(A) 14400

(A) change in dimensions(B) scale formation	(C) closure of defects(D) grain orientation
Q.17 Which of the following processes	(GATE PI 2009) is used to manufacture products with controlled porosity?
(A) Casting(B) Welding	(C) Forming(D) Powder metallurgy
-	(GATE PI 2009) should be fed for effective oxy-fuel cutting of stainless
steel? (A) Steel (B) Aluminum Q.19 An autocollimator is used to	(C) Copper (D) Ceramic (GATE PI 2009)
(A) measure small angular displace(B) compare known and unknown(C) measure the flatness error(D) measure roundness error between	dimensions
	(GATE PI 2009) commended for machining of ferrous metals due to
(A) high tool hardness(B) high thermal conductivity of w(C) poor tool toughness(D) chemical affinity of tool materi	
•	(GATE PI 2009) ing the following system of linear equations is
	$x + 2x_2 - 2x_3 = 4$
	$2x + x_2 + x_3 = -2$
	$-x + x_2 - x_3 = 2$
(A) -12 (B) -2	(C) 0 (D) 12
Q.22 The displacement and acceleration figures: The nature of the displacement	(GATE PI 2009) a of a cam follower mechanism are plotted in the following ement curve is:
(A) Cubic(B) Quadratic	(C) Simple harmonic(D) Linear
Q.23 The solution of the differential e $x = 0$, (ii) $\frac{dy}{dx} = 1$ at $x=1$ is (A) $y = 1$ (B) $y = x$	(GATE PI 2009) quation $\frac{d^2r}{dx^2} = 0$ with boundary conditions: (i) $\frac{dy}{dx} = 1$ at



- (C) y = x + C, where C is an arbitrary constant
- (D) $y = C_1x + C_2$, where C_1, C_2 are arbitrary constants

(GATE PI 2009)

Q.24 The line integral of the vector function $\mathbf{F} = 2x + x^2 \hat{\mathbf{j}}$ along the x-axis from x = 1 to x = 2

(A)0

(B)2.33

(C)3

(D)5.33

(GATE PI 2009)

Q.25 Using direct extrusion process, a round billet of 100 mm length and 50 mm diameter is extruded. Considering an ideal deformation process (no friction and no redundant work), extrusion ratio 4, and average flow stress of material 300 MPa, the pressure (in MPa) on the ram will be

(A)416

(B)624

(C)700

(D)832

(GATE PI 2009)

Q.26 A friction clutch is designed to transmit 15 horsepower at 1500 rpm. The torque (in N·m) experienced by the clutch is

(A) 1.19

(C) 71.24

(B) 7.46

(D) 447.61

(GATE PI 2009)

Q.27 A manufacturer has set up an assembly line where first, Task I is performed in Workstation 1 for 0.3 minutes; then Task II is performed in Workstation 2 for 0.4 minutes; and finally Task III is performed in Workstation 3 for 0.3 minutes. The efficiency (in %) of this assembly line setup is

(A) 33.33

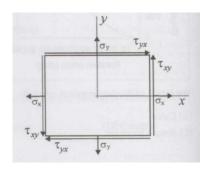
(C) 75.33

(B) 64.33

(D) 83.33

(GATE PI 2009)

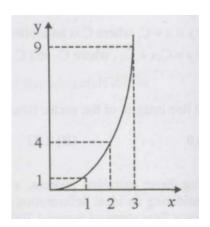
Q.28 A biaxial stress element is subjected to tensile and shear stresses as shown in the figure. If $\sigma_1 = 40$ MPa, $\sigma_y = 20$ MPa and $T_{xy} = T_{yx} = 15$ MPa. The principal normal stresses (in MPa) are:



- (A) 5 and 55
- (B) 10 and 30
- (C) 12 and 48
- (D) 20 and 40

(GATE PI 2009)

Q.29 The area under the curve shown, between x = 1 and x = 3, to be evaluated using the trapezoidal rule. The following points on the curve are given:



Point	X coordinate (m)	Y coordinate (m)
1	1	1
2	2	4
3	3	9

The evaluated area (in m²) will be

- (A) 7
- (B) 8.67

- (C) 9
- (D) 18

(GATE PI 2009)

- Q.30 The pressure drop for laminar flow of a liquid in a smooth pipe at normal temperature and pressure is
 - (A) directly proportional to density
- (C) independent of density
- (B) inversely proportional to density
- (D) proportional to density^{0.75}

(GATE PI 2009)

Q.31	A titanium sheet of 5.0 mm thickness is cut by wire-cut EDM process using a wire of 1.0
	mm diameter. A uniform spark gap of 0.5 mm on both sides of the wire is maintained during
	cutting operation. If the feed rate of the wire into the sheet is 20 mm/min, the material
	removal rate (in mm ³ /min) will be

(A) 150

(C) 300

(B) 200

(D) 400

(GATE PI 2009)

Q.32 Autogenous gas tungsten arc welding of a steel plate is carried out with welding current of 500 A, voltage of 20 V, and weld speed of 20 mm/min. Consider the heat transfer efficiency from the arc to the weld pool as 90%. The heat input per unit length (in kJ/mm) is

(A) 0.25

(B) 0.35

(C) 0.45

(D) 0.55

(GATE PI 2009)

Q.33 Consider steady flow of water in a situation where two pipe lines (Pipe 1 and Pipe 2) combine into a single pipeline (Pipe 3) as shown in the figure. The cross-sectional areas of all three pipelines are constant. The following data is given:

Pipe number	Area(m ²)	Velocity(m/s)
1	1	1
2	2	2
3	2.5	?

Assuming water properties and velocities to be uniform across the cross sections of the inlets and the outlet, the exit velocity (in m/s) in pipe 3 is

(A) 1

(C) 2

(B) 1.5

(D) 2.5

(GATE PI 2009)

Q.34 Match the following:

Group I (Layout types)

- P. Process layout
- Q. Product flow layout
- R. Fixed position layout
- S. Cellular layout
- (A) P-4, Q-1, R-3, S-2
- (B) P-4, Q-3, R-2, S-1

Group II (Layout characteristics)

- 1. Inflexible to significant changes in product design
- 2. Distinct part families and expanded worker training
- 3. Low equipment utilization and high skill requirement
- 4. Large work-in-process and increased material handling
- (C) P-2, Q-1, R-4, S-3
- (D) P-1, Q-4, R-3, S-2

(GATE PI 2009)

Q.35 Consider the joint probability mass function of random variables X and Y as shown in the table below:

For instance, $P{X = 1, Y = 2} = 0.3$

	X=1	X=2
Y=1	0.2	0.3
Y=2	0.3	0.1
Y=3	0.1	

The value of $P\{X = 2|Y = 2\}$ is (B) 0.25 C) 0.40 (D) 0.75 (A) 0.10 (GATE PI 2009) Q.36 A grocery store faces a demand of 50 units of soap per day. The store orders soap periodically. It costs Rs. 100 to initiate a purchase order. It costs Rs. 0.04 per soap per day to store the soap. The lead time between placing and receiving the order is 4 days. The optimal inventory policy for ordering soap is to (A) order 500 units when inventory drops to 200 units (B) order 500 units when inventory drops to 100 units (C) order 1000 units when inventory drops to 200 units (D) order 1000 units when inventory drops to 100 units (GATE PI 2009) Q.37 A disk of 200 mm diameter is blanked from a strip of an aluminum alloy of thickness 3.2 mm. The material shear strength to fracture is 150 MPa. The blanking force (in kN) is (A) 291 (B) 301 (C) 311 (D) 321 (GATE PI 2009) Q.38 Match the following: **Group I (Product) Group II (Manufacturing process)** P. Refrigerator liners 1. Filament winding Q. Composite pressure vessels 2. Thermoforming R. Hollow parts of thermoset plastics 3. Calendering S. Rubber sheets 4. Rotational moulding (A) P-2, Q-1, R-4, S-3 (C) P-1, Q-4, R-2, S-3 (B) P-1, Q-2, R-3, S-4 (D) P-2, Q-4, R-1, S-3 (GATE PI 2009) Q.39 Match the following: **Group I (Device) Group II (Function)** P. Jig 1. helps to place the workpiece in the same position cycle after cycle Q. Fixture R. Clamp 2. holds the workpiece only 3. holds and positions the workpiece S. Locator 4. holds and positions the workpiece and guides the cutting tool during a machining operation (A) P-4, Q-3, R-1, S-2 (C) P-1, Q-4, R-3, S-2

(GATE PI 2009)

Q.40 A spur gear having a pressure angle of 20°, module of 4 mm and 40 teeth is to be inspected for its pitch circle diameter using two rollers (test plug method). If the centres of the rollers lie on the pitch circle, the suitable roller diameter (in mm) and the resulting distance (in mm) between the rollers placed in opposite spaces will respectively be

(D) P-4, Q-3, R-2, S-1

(B) P-1, Q-2, R-3, S-4

(A) 2.9 and 82.9(B) 2.9 and 165.9	(C) 5.9 and 82.9 (D) 5.9 and 165.9
bilities of 0.80, 0.85 and 0.90 res	(GATE PI 2009) ag three independent components I, II and III, with relia- spectively. If the company decides to add one redundant eliability, then the reliability of the product is (C) 0.837 (D) 0.969
0.40.63	(GATE PI 2009)
<u> </u>	
Q.43 A spare parts retail shop has sales	(GATE PI 2009) of Rs. 4,00,000 and a profit of Rs. 50,000 for a product, me (PV) ratio is 25%. The margin of safety = profit / PV es (in Rs.) is
(A) 20,000 (B) 40,000	(C) 2,00,000 (D) 4,00,000
	(GATE PI 2009)
Stan Pay for production Pay for production i	oduction of a worker = 12 jobs per hour dard job rate = Rs. 3.00 per job less than standard = 85% of standard job rate more than standard = 120% of standard job rate e of 11, 13 and 15 jobs per hour. The total pay for three
(A) Rs. 117.00 (B) Rs. 128.85	(C) Rs. 1404.00 (D) Rs. 1546.20
0.45 M. (1.4. C.II	(GATE PI 2009)
Q.45 Match the following: Group I (Protection type)	Group II (Example in the Indian context)
P. PatentQ. TrademarkR. CopyrightS. Industrial design	 Manual of a product Appearance of an MP3 player Logo of a company Microprocessor

(A) P-2, Q-4, R-3, S-1 (B) P-4, Q-1, R-3, S-2	(C) P-2, Q-3, R-4, S-1 (D) P-4, Q-3, R-1, S-2
	(GATE PI 2009)
Q.46 Match the following: Group I (Design aspect)	Group II (Description)
P. Form designQ. Concurrent engineeringR. Value analysisS. Product life cycle	 Introduction, growth, maturity and decline Determines cost of each function of the design Integration of product design and manufacturing Appearance, shape, colour and size of product
(A) P-4, Q-1, R-2, S-3 (B) P-3, Q-2, R-4, S-1	(C) P-4, Q-3, R-2, S-1 (D) P-4, Q-2, R-3, S-1
	(GATE PI 2009) on, the tool life obtained is 10 min at a cutting speed atting speed, the tool life is 30 min. The value of index is
(A) 0.262 (B) 0.323	(C) 0.423 (D) 0.521
- ·	(GATE PI 2009) height equal to D, and a solid cube of side L are being ial. Assuming there is no superheat in both cases, the clinder to that of the cube is
(A) $(L/D)^2$ (B) $(2L/D)^2$	(C) $(2D/L)^2$ (D) $(D/L)^2$
Q.49 Following are some possible character. P. Low inter-particle friction Q. High inter-particle friction R. Low porosity S. High porosity If the angle of repose for a pile of particle friction.	(GATE PI 2009) steristics of a pile of powder mixture:
(A) P and R (B) P and S	(C) Q and S (D) Q and R
O 50 Match the following:	(GATE PI 2009)
Q.50 Match the following: Group I	Group II
P. Relational DBMSQ. Primary keyR. Retrieving dataS. Boolean search	 SQL AND, OR Tables, columns and rows Columns that uniquely identify a row

(A) P-3, Q-4, R-2, S-1

(C) P-3, Q-4, R-1, S-2

(B) P-3, Q-1, R-4, S-2

(D) P-4, Q-1, R-2, S-3

(GATE PI 2009)

Common Data Questions

Common Data for Questions 51 and 52:

Consider the Linear Programming Problem (LPP)

Maximize $z = 4x_1 + 3x_2 + 2x_3$

Subject to:

$$2x_1 + x_2 + 2x_3 \le 50$$
 (constraint 1)
 $x_1 + x_2 + x_3 \le 30$ (constraint 2)
 $x_1, x_2, x_3 \ge 0$

The associated simplex tableau at optimality is shown below, where s_1 and s_2 represent the slacks for constraints 1 and 2 respectively.

	x_1	x_2	x_3	s_1	s_2	RHS
z-row	0	0	2	1	2	110
x_1	1	0	1	1	-1	20
x_2	0	1	0	-1	2	10

- Q.51 Basic variables in the optimal solution are
 - (A) s_1 and s_2

(C) $x_1, x_2 \text{ and } x_3$

(B) x_1 and x_2

(D) x_3 , s_1 and s_2

(GATE PI 2009)

- Q.52 Suppose that in the LPP given, the right hand side of constraint 1 changes from 50 to 40. The new objective value is
 - (A) 90

(C) 110

(B) 100

(D) 120

(GATE PI 2009)

Common Data for Questions 53 and 54:

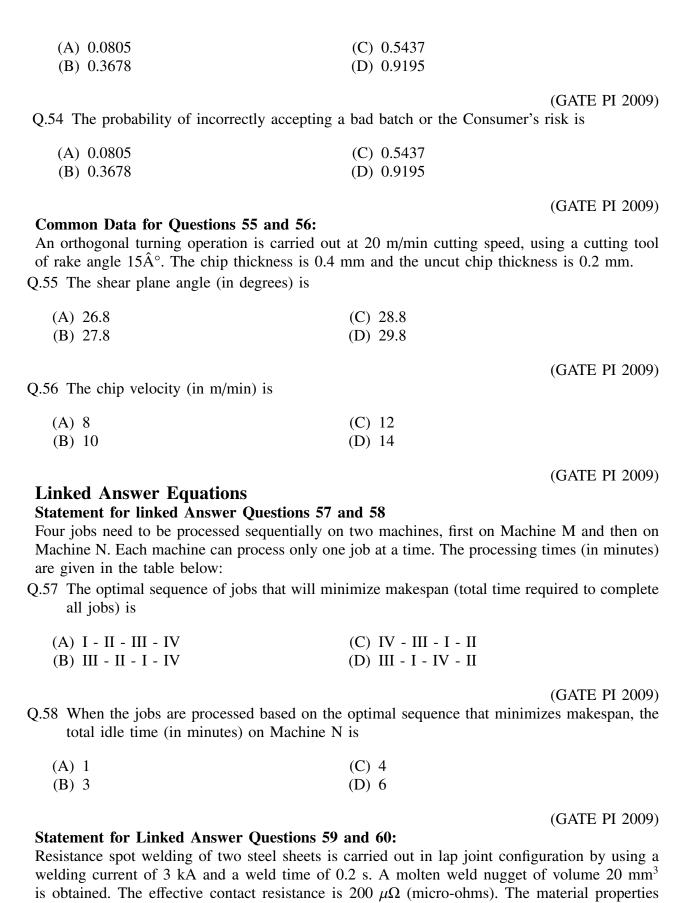
In acceptance sampling, the probability distribution of the number of defectives X in a sample can be approximated as a Poisson distribution,

Prob
$$\{X = k\} = \frac{(np)^k e^{-np}}{k!} \ k = 0, 1, 2, ...$$

where n is the sample size and p is the actual proportion or percent of defective items in a batch.

A company receives a shipment batch of N = 2000 items. The sampling plan followed by the company is to sample n = 50 items from the batch and accept the batch if the number of defective items is 2 or less. Let the Acceptable Quality Level (AQL) be 0.02 and the Lot Tolerance Percent Defective (LTPD) be 0.05.

Q.53 The probability of incorrectly rejecting a good batch or the Producer's risk is



temperature: 1520°C,(iv) sy The ambient temperature is	. 6	
(A) 324 (B) 334	(C) 344 (D) 354	
Q.60) Heat (in Joules) dissipa	(GATI red to the base metal will be (neglecting all other heat le	E PI 2009) osses)
(A) 10 (B) 16	(C) 22 (D) 32	

(GATE PI 2009)